

Low IQ High Light Load Efficiency Synchronous Boost Converter

FEATURES

- Deliver 3.3V at 60mA from a Single Alkaline/Ni-MH or 3.3V at 120mA from Two Cells
- Up to 94% Efficiency
- Low Shutdown Current: < 1µA
- Low Quiescent Current: 12µA.
- Low No-load Input Current (see Typical Performance Characteristics for detail)
- Output Disconnect by Shutdown Function
- Small SOT23-6 Package

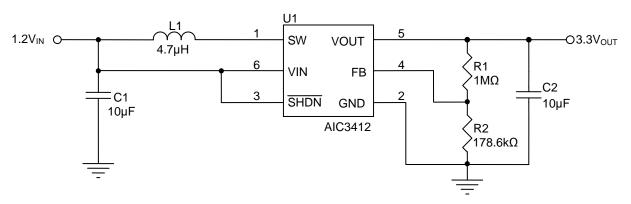
APPLICATIONS

- Wireless Mice
- Medical Instruments
- Smart Phones
- **Bluetooth Devices**

DESCRIPTION

The AIC3412 is a synchronous step-up DC/DC converter. That is base on constant Off Time/PSM controller topology. The IC enters PSM mode automatically at light load, the goal is to improve efficiency and reduce quiescent current. The AIC3412 provide a complete power supply solution for products powered by one or two Alkaline, Ni-Cd, or Ni-MH battery cells. It stays in operation with supply voltages down to 0.7V. The implemented boost converter is based on a constant Off Time/PSM controller topology using an internal synchronous rectifier to obtain maximum efficiency. A low-EMI mode is implemented to reduce ringing and in effect lower radiated electromagnetic energy when the converter enters the discontinuous conduction mode.

TYPICAL APPLICATION CIRCUITS



One Cell Step-Up DC/DC Converter Fig. 1

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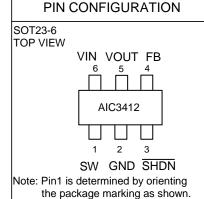
ORDERING INFORMATION

AIC3412X<u>XXXX</u>



Example: AIC3412GG6TR

→ in SOT23-6 Green Package & Tape & Reel Packing Type

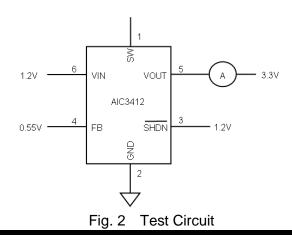


ABSOLUTE MAXIMUM RATINGS

Pin Voltage: FB, SHDN, OUT, VIN	-0.3 V to 6V
Pin Voltage: SW	
DC	-0.3 V to 6V
Pulsed < 100ns	-0.3 V to 7V
Operating Ambient Temperature Range T _A	-40°C to 85°C
Operating Maximum Junction Temperature T _J	150°C
Storage Temperature Range T _{STG}	-65°C to 150°C
Lead Temperature (Soldering 10 Sec.)	260°C
Thermal Resistance Junction to Ambient	250°C/W
(Assume no Ambient Airflow, no Heatsink)	

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

TEST CIRCUIT





ELECTRICAL CHARACTERISTICS

(Typical application circuit, and the ambient temperature=25°C, V_{IN} =1.2V, V_{OUT} =3.3V, unless otherwise specified) (Note1)

PARAMETER	TEST CONDITION		SYMBOL	MIN	ТҮР	МАХ	UNIT
Output Voltage Range			V _{OUT}	1.65		5.5	V
Minimum Start Up Voltage		RL= 3.3kOhm			0.75	0.9	V
Input Operation Voltage				0.7		5	V
UVLO of Vin		Vin decreasing			0.5	0.7	V
Quiescent Current (PSM)	V _{OUT}	V _{IN} =1.2V, V _{OUT} =3.3V, V _{FB} =0.55V (Note 2)	Ι _Q		12	25	μA
IC Shut Down Current	SF	HDN = 0V, V _{OUT} =1.1V	I _{SD}		0.01	1	μA
Feedback Voltage			V _{FB}	490	500	510	mV
FB Input Leakage Current	V _{FB} =1.3V		I _{FB}		1	50	nA
Inductor current ripple			I _{LH}		200		mA
Constant off time	V _{IN} =1.2V, V _{OUT} =3.3V		T _{OFF}		400		ns
Line Regulation	V _{IN} <v<sub>OUT (Note 3)</v<sub>				0.5%		
Load Regulation	V _{IN} <v<sub>OUT (Note 3)</v<sub>				0.5%		
NMOS Switch Leakage	V _{SW} =5V				0.1	5	μA
PMOS Switch Leakage	V _{SW} =5V, V _{OUT} =0V				0.1	10	μA
NMOS Switch On Resistance	V _{IN} =1.2V, V _{OUT} =3.3V				480		mΩ
PMOS Switch On Resistance	V _{IN} =1.2V, V _{OUT} =3.3V				800		mΩ
SHDN High Threshold Voltage	V _{IN} =1.2V			0.8			V
SHDN Low Threshold Voltage	V _{IN} =1.2V					0.2	V
SHDN Pin Input Current		SHDN = 5.5V	I _{SHDN}		0.01	1.0	μA
NMOS Current Limit	VI	_N =1.2V, V _{OUT} =3.3V		0.28	0.48	0.68	А
Over Temperature Protection					150		°C
Over Temperature Hysteresis					30		°C

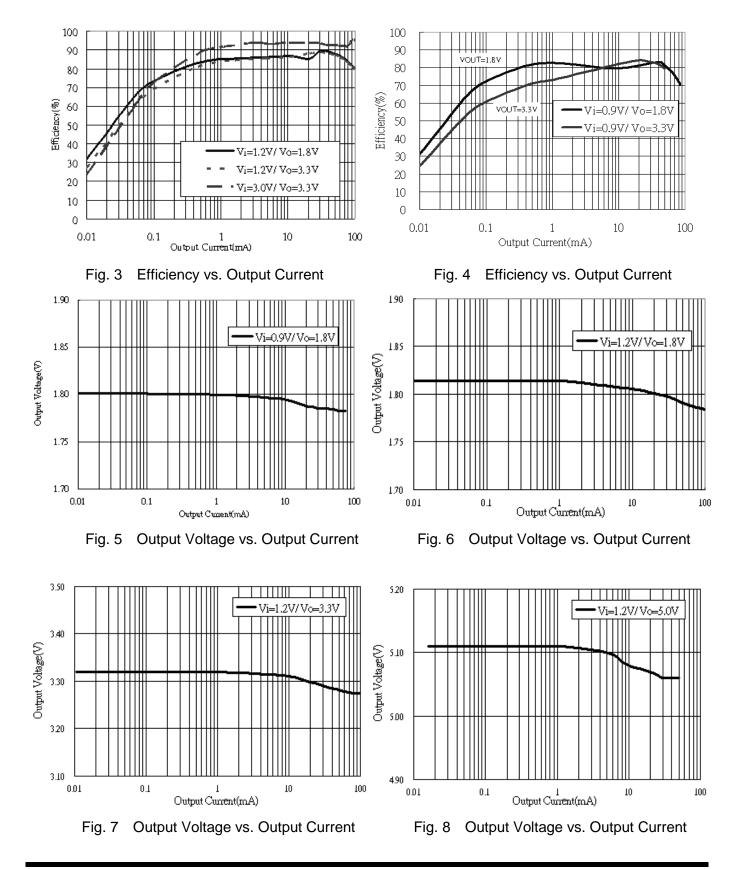
Note 1: Specifications are production tested at T_A=25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

Note 2: The test circuit shown in Fig. 2.

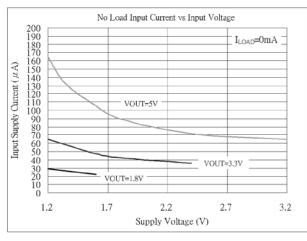
Note 3: Guarantee by Design.

TYPICAL PERFORMANCE CHARACTERISTICS

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TYPICAL PERFORMANCE CHARACTERISTICS(Continued)



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Fig. 9 Input Supply Current vs. Supply Voltage

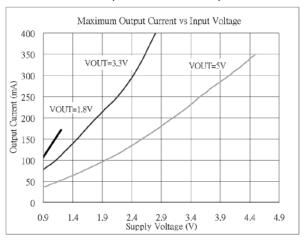


Fig. 10 Output Current vs. Supply Voltage

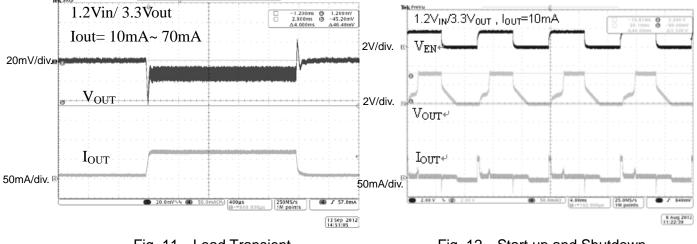


Fig. 11 Load Transient

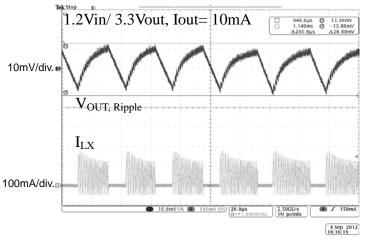
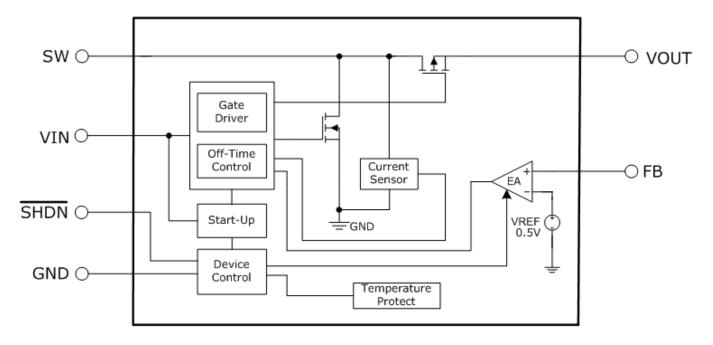


Fig. 13 Output Voltage Ripple

Fig. 12 Start up and Shutdown

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FUNCTIONAL BLOCK DIAGRAM



PIN DESCRIPTIONS

- 1. SW Switch Pin. Connect Inductor between VIN and this pin.
- 2. GND- Signal and Power Ground
- 3. \overline{SHDN} Logic Controlled Shutdown Input. \overline{SHDN} = High: Normal Operation \overline{SHDN} = Low: IC shutdown
- 4. FB Feedback Input to Error Amplifier. Connect resistor divider tap to this pin.
- 5. VOUT- Output Voltage Sense and Drain of the Internal Synchronous Rectifier.
- 6. VIN Input Supply Pin.

APPLICATION INFORMATION

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The AIC3412 is a synchronous step-up DC-DC converter. It is based on constant Off Time/PSM controller topology. At the beginning of each clock cycle, the main switch (NMOS) is turned on and the inductor current starts to ramp. After the sense current signal equals the error amplifier (EA) output, the main switch is turned off and the synchronous switch (PMOS) is turned on. The device can operate with an input voltage below 1V; the typical start-up voltage is 0.75V.

Current Limit

The over current protection is to limit the switch current. The output Voltage will be dropped when over current is happened. The current limit amplifier will turn off switch once the current exceeds its threshold.

Zero Current Comparator

The zero current comparator monitors the inductor current to the output and shuts off the synchronous rectifier, This prevents the inductor current from reversing in polarity improving efficiency at light loads.

Device Shutdown

When SHDN is set logic high, the AIC3412 is put into active mode operation. If SHDN is set logic low, the device is put into shutdown mode and consumes less than 1 μ A of current. At the shutdown mode, the synchronous switch will turn off and the output voltage of AIC3412 step-up converter will reduce to 0V.After start-up, the internal circuitry is supplied by VOUT, however, if shutdown mode is enabled, the internal circuitry will be supplied by the input source again.

Adjustable Output Voltage

An external resistor divider is used to set the output voltage. The output voltage of the switching regulator (V_{OUT}) is determined by the following equation:

$$V_{OUT} = V_{FB} \times \left(1 + \frac{R_1}{R_2}\right)$$

Where V_{FB} is 0.5V reference voltage.

Input Inductor Selection

A 2.2 μ H~6.8 μ H input inductor is commanded for most AIC3412 applications. The 4.7 μ H input inductor can get the good performance over the whole converter ratio cases. The inductor which is smaller than 2.2 μ H is not recommended to use. It is important to ensure the inductor saturation current exceeding the peak inductor current in application to prevent core saturation.

Input Capacitor Selection

Surfaces mount 4.7µF or greater, X5R or X7R, ceramic capacitor is suggested for the input capacitor. The input capacitor provides a low impedance loop for the edges of pulsed current drawn by the AIC3412. Low ESR/ESL X7R and X5R ceramic capacitors are ideal for this function. To minimize stray inductance, the capacitor should be placed as close as possible to the IC. This keeps the high frequency content of the input current localized, minimizing EMI and input voltage ripple. Always examine the ceramic capacitor DC voltage coefficient characteristics to get the proper value.

Output Capacitor Selection

The output capacitor limits the output ripple and provides holdup during large load transitions. A 4.7μ F to 10μ F, X5R or X7R, ceramic capacitor is suggested for the output capacitor. Typically the recommended capacitor range provides sufficient bulk capacitance to stabilize the output voltage during large load transitions and has the low ESR and ESL characteristics necessary for low output voltage ripple.

PCB Layout Guidance

This is a considerably high frequency for DC-DC converters. PCB layout is important to guarantee satisfac-

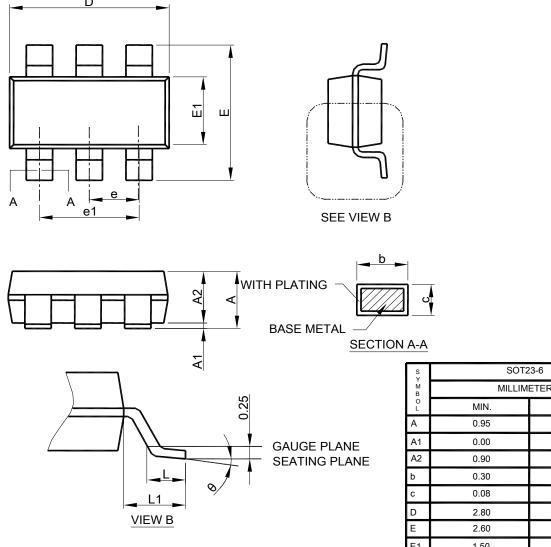


tory performance. It is recommended to make traces of the power loop, especially where the switching node is involved, as short and wide as possible. First of all, the inductor, input and output capacitor should be as close as possible to the device. Feedback and shutdown circuits should avoid the proximity of large AC signals involving the power inductor and switching node.



PHYSICAL DIMENSIONS

• SOT23-6



Note : 1. Refer to JEDEC MO-178AB.

- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.
- 3. Dimension "E1" does not include inter-lead flash or protrusions.
- 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

M B O L	MILLIMETERS				
0 L	MIN.	MAX.			
А	0.95	1.45			
A1	0.00	0.15			
A2	0.90	1.30			
b	0.30	0.50			
С	0.08	0.22			
D	2.80	3.00			
E	2.60	3.00			
E1	1.50	1.70			
е	0.95 BSC				
e1	1.90 BSC				
L	0.30	0.60			
L1	0.60 REF				
θ	0°	8°			

Note:

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